

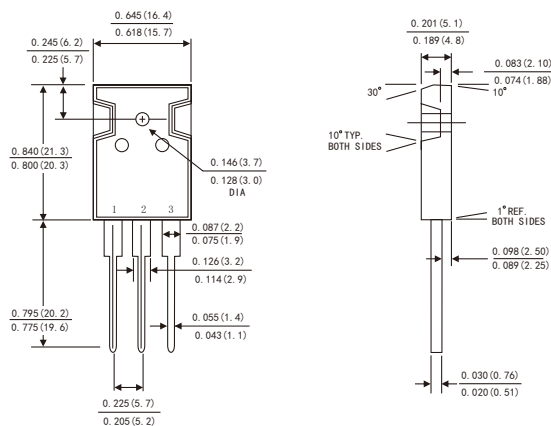
DESCRIPTION

SiC Schottky Diode has no switching loss, provides improved system efficiency against Si diodes by utilizing new semiconductor material—Silicon Carbide, enables higher operating frequency, and helps increasing power density and reduction of system size /cost. Its high reliability ensures robust operation during surge or over_voltage conditions.

FEATURES

- Max Junction Temperature 175° C
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery/No Forward Recovery

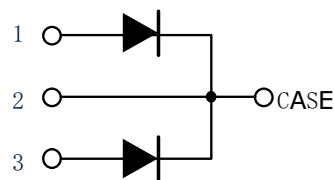
TO-247AB



Dimensions in inches and (millimeters)

MECHANICAL DATA

- Case: JEDEC TO-247AB
- Molding compound meets UL94V-0 flammability rating
- Terminals: Lead solderable per J-STD-002 and JESD22-B102
- Polarity: As marked
- Mounting Torque: 10 in-lbs maximum



TYPICAL APPLICATIONS

- General Purpose
- SMPS, Solar inverter, UPS
- Power Switching Circuits

KEY PERFORMANCE AND PACKAGE PARAMETERS (leg/device)

Type	V _{DC}	I _F	Q _c	T _{J,max}	Package
SC10120PT	1200V	5A/10A	19nC/38nC	175°C	TO-247AB

RATINGS AND CHARACTERISTIC OF SC10120PT

MAXIMUM RATINGS

(Ratings at 25°C ambient temperature unless otherwise specified)

Parameter	Symbol	Value (leg/device)	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	1200	V
Continuous Forward Current for $R_{th(j-c)}$	I_F	5/10 ($T_c=156^\circ\text{C}$) 17/34 ($T_c=25^\circ\text{C}$)	A
Non-Repetitive Forward Surge Current (Half-Sine Pulse, $t_p=8.3\text{ms}$)	$I_{F,SM}$	77/154 ($T_c=25^\circ\text{C}$) 70/140 ($T_c=150^\circ\text{C}$)	A
I^2t value	$\int i^2t$	25/98 ($T_c=25^\circ\text{C}$) 20/80 ($T_c=150^\circ\text{C}$)	A^2S
Diode dv/dt ruggedness($V_R=0\dots960\text{V}$)	dv/dt	80	V/nS
Power dissipation for $R_{th(j-c,max)}$ ($T_c=25^\circ\text{C}$)	P_{tot}	150/150	W
Operating junction temperature range	T_j	-55...175	$^\circ\text{C}$
Storage temperature range	T_{stg}	-55...175	$^\circ\text{C}$

THERMAL CHARACTERISTICS ($T_A=25^\circ\text{C}$ Unless otherwise noted)

Parameter	Symbol	Value		Unit
		Typ	Max	
Diode thermal resistance junction-case	$R_{th(j-c)}$	0.8/0.6	1.0/0.8	K/W

RATINGS AND CHARACTERISTIC OF SC10120PT

ELECTRICAL CHARACTERISTICS (T_A=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Value(leg/device)			Unit
			min	typ	max	
DC blocking voltage	V _{DC}	T _j =25...175°C	1200			V
Diode forward voltage	V _F	IF=5A/10A T _j =25°C IF=5A/10A T _j =125°C IF=5A/10A T _j =175°C		1.8 2.4 3.0	2.0 2.6 3.2	V
Reverse current	I _R	VR=1200V T _j =25°C VR=1200V T _j =125°C VR=1200V T _j =175°C			20/40 100/200 200/400	uA

DYNAMIC CHARACTERISTICS(at T_j=25°C, unless otherwise specified)

Parameter	Symbol	conditions	Value(leg/device)			Unit
			min	typ	max	
Total capacitive charge	Q _c	VR=1200V,IF=5A di/dt=200A/uS T _j =25°C		19/38		nC
Total capacitance	C	V _R =0V,f=1MHz V _R =400V,f=1MHz V _R =800V,f=1MHz T _j =25°C		385/770 28/56 22/44		pF

RATINGS AND CHARACTERISTIC OF SC10120PT

FIG.1-FORWARD CURRENT DERATING CURVE (device)

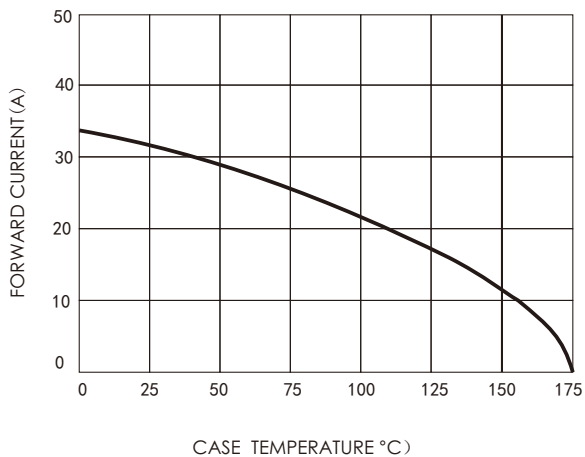


FIG.2-TYPICAL JUNCTION CAPACITANCE (pre leg)

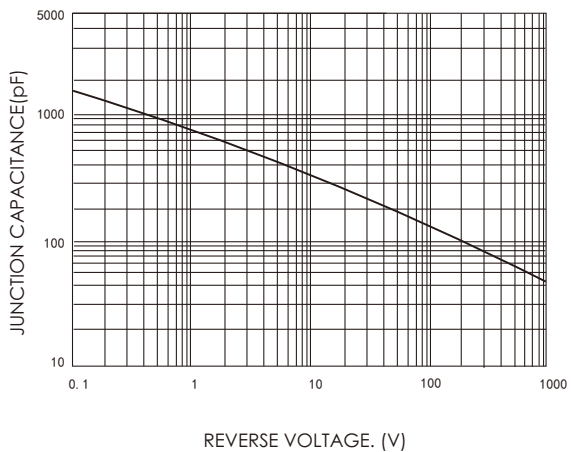


FIG.3-FORWARD CURRENT DERATING CURVE(device)

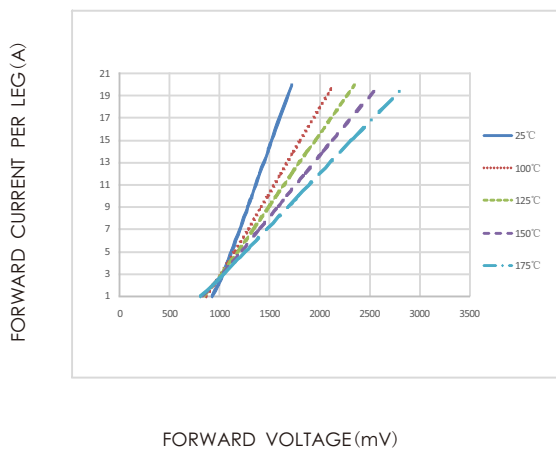
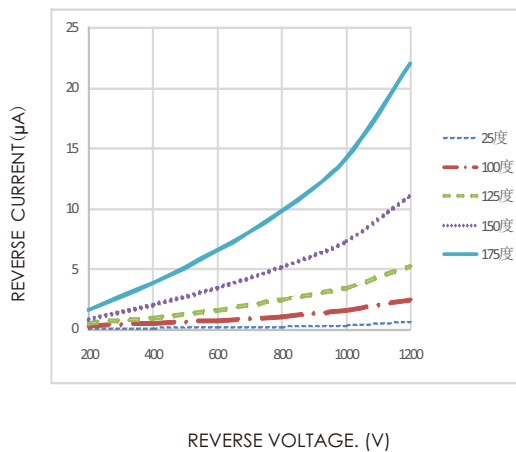


FIG.4-REVERSE CHARACTERISTICS(pre leg)



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